Welcome to O-leading

O-Leading strives to be your one stop solution partner in EMS supply chain, including PCB design, PCB fabrication and PCB assembly (PCBA).We provide some of the most advanced PCB technology, including HDI PCBs,multilayer PCBs, Rigid-Flexible PCBs.We can support from quick turn prototype to medium & mass Production. printed circuit boards supplier

In general, our global customers are very impressed with our services:rapid response, competitive price and quality commitment.Providing more valuable technical service and overall solution is the way Oleading forward.

Looking to the future, O-leading will concentrate on the innovation and development of electronics manufacturing technology as always, and make persistent efforts on PCB & PCBA one-stop service to provide first-class services and create more value for our customers.

We are professional PCB manufacturer with ten years experiences. Products range-single, double side, multi-layer PCB, flexible PCB and MCPCB.

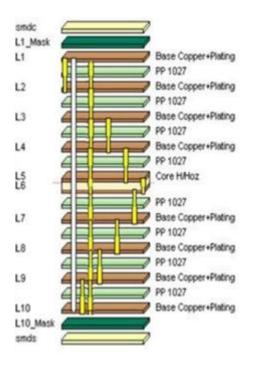
We can provide fast prototype service – S/S in 24hrs, 4-8layers in 48-96 working hrs production time. oem mobile phones pcb circuit board with power supply.

Copper platee holes minmum 0.025 avg, 0.020 min. Holes may not be plugged.

Pack with colorless transparent bubble film, 25 PCS/ bag, put desiccant in flank, put humidity indicator card on top side.

<u>multilayer PCB manufacturer in china</u>

Layer structure









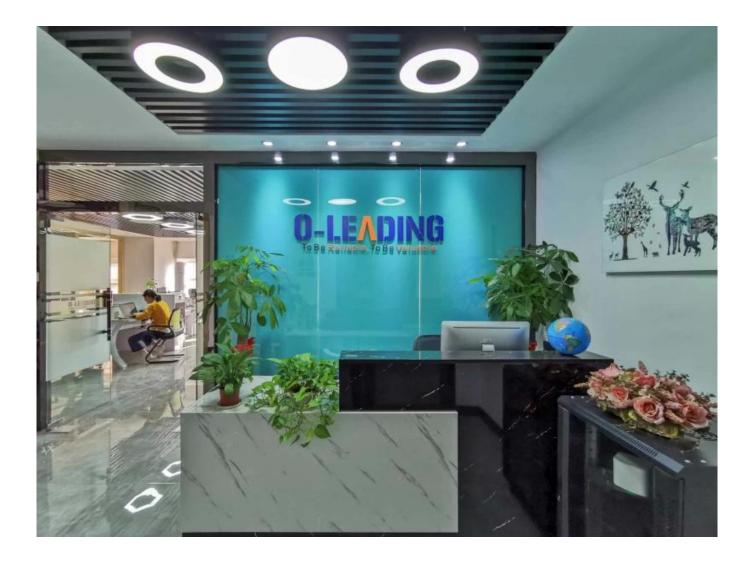
www.o-leading.com





High quality pcb wholesalers





Factory PCB





Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

- Factory SMT











Certifications





O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

Test Report

SGS

Test Report

No. SZXEC1900530401

Date: 30 Mar 2019 Page 2 of 6

Test Part Description :

Test Results :

Specimen No. SGS Sample ID Description SN1 SZX19-005304.001 Green"PCB"

Date: 30 Mar 2019 Page 1 of 6

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

No. SZXEC1900530401

| SGS Job No. : | RP19-005089 - SZ |
|---------------------------|---|
| Date of Sample Received : | 22 Mar 2019 |
| Testing Period : | 22 Mar 2019 - 30 Mar 2019 |
| Test Requested : | Selected test(s) as requested by client. |
| Test Method : | Please refer to next page(s). |
| Test Results : | Please refer to next page(s). |
| Conclusion : | Based on the performed tests on submitted sample(s), the results of Lead, Marcury, Cadmium, Horavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Big2-ethylhexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dbutyl phthalate (DBP), and Disbotyl phthalate (DBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/85/EU. |

1313.FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

Signed for and on behalf of SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina

Tina Fan Approved Signatory



Member of the SGS Group (SGS SA)

Remarks : (1) 1 mg/kg = 1 ppm = 0.0001%
(2) MDL = Method Detection Limit (3) ND = Not Detected (< MDL)

(4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/85/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC 62321-5:2013, IEC 62321-7:2:2017, IEC 62321-6:2015 and IEC 62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

| Test Item(s) | Limit | Unit | MDL | 001 |
|------------------------------|-------|-------|-----|-----|
| Cadmium (Cd) | 100 | mg/kg | 2 | ND |
| _ead (Pb) | 1,000 | mg/kg | 2 | 8 |
| Mercury (Hg) | 1,000 | mg/kg | 2 | ND |
| Hexavalent Chromium (Cr(VI)) | 1,000 | mg/kg | 8 | ND |
| Sum of PBBs | 1.000 | mg/kg | | ND |
| Monobromobiphenyl | | mg/kg | 5 | ND |
| Dibromobiphenyl | 12 | mg/kg | 5 | ND |
| Tribromobiphenyl | | mg/kg | 5 | ND |
| Tetrabromobiphenyl | | mg/kg | 5 | ND |
| Pentabromobiphenyl | | mg/kg | 5 | ND |
| Hexabromobiphenyl | | mg/kg | 5 | ND |
| Heptabromobiphenyl | - | mg/kg | 5 | ND |
| Octabromobiphenyl | | mg/kg | 5 | ND |
| Nonabromobiphenyl | - | mg/kg | 5 | ND |
| Decabromobiphenyl | | mg/kg | 5 | ND |
| Sum of PBDEs | 1,000 | mg/kg | | ND |
| Monobromodiphenyl ether | | mg/kg | 5 | ND |
| Dibromodiphen yl ether | | mg/kg | 5 | ND |
| Tribromodiphenyl ether | | mg/kg | 5 | ND |
| Tetrabromodiphenyl ether | - | mg/kg | 5 | ND |
| Pentabromodiphenyl ether | - | mg/kg | 5 | ND |



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UL Product iQ™



E490354

ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD

ROOM 1205, 12/F TAI SANG BANK BLDG 130-132 DES VOEUS ROAD CENTRAL, HONG KONG

| | Cond | Width | | | Max | | | Max | | | |
|-------------------------------------|-----------------|-----------------|----------------------|-----|------------|------|-----|------|-------|-------|---|
| | | Min | Cond | SS/ | Area | Solo | der | Oper | | Meets | с |
| | Min | Edge | Thk | DS/ | Diam | Lim | its | Temp | Flame | UL796 | т |
| Туре | mm(in) | mm(in) | mic(mil) | DSO | mm(in) | с | sec | с | Class | DSR | L |
| Multilayer (m | ass laminate) p | rinted wiring l | ooards. | | | | | | | | |
| O-LEADING- 401 | 0.1 (0.004) | 0.3 (0.012) | 34 (1.34) | DS | 12.7 (0.5) | 260 | 10 | 130 | V-0 | - | - |
| O-LEADING- 407 | 0.08 (0.003) | 0.2 (0.008) | 17 (0.67) | DS | 9.7 (0.4) | 260 | 10 | 130 | V-0 | All | - |
| Multilayer pri | nted wiring bo | ards. | A., | | | | | | | | |
| O-LEADING- 408 | 0.125 (0.005) | 0.125 (0.005) | 12 (0.47) Int:136 | DS | 50.8 (2.0) | 280 | 20 | 130 | V-0 | All | * |
| Single layer printed wiring boards. | | | | | | | | | | | |
| O-LEADING- 002 | 0.38 (0.015) | 1.14 (0.045) | 34 (1.34) | SS | 19.1 (0.8) | 260 | 10 | 105 | V-0 | All | - |
| O-LEADING- 003 | 0.38 (0.015) | 1.14 (0.045) | 34 (1.34) | SS | 19.1 (0.8) | 260 | 10 | 130 | V-0 | | - |
| O-LEADING- 033 | 0.15 (0.006) | 0.3 (0.012) | 34 (1.34) | SS | 25.4 (1.0) | 260 | 10 | 120 | V-0 | All | - |
| O-LEADING- 205 | 0.1 (0.004) | 0.3 (0.012) | 34 (1.34) | DS | 69.6 (2.7) | 260 | 10 | 130 | V-0 | All | - |
| O-LEADING- 206 | 0.15 (0.006) | 0.33 (0.013) | 17 (0.67) | DS | 69.6 (2.7) | 260 | 10 | 130 | V-0 | All | - |
| O-LEADING- D01 | 0.14 (0.006) | 0.15 (0.006) | 33 (1.30) | DS | 25.4 (1.0) | 260 | 10 | 130 | V-0 | All | * |
| O-LEADING- S01 | 0.25 (0.010) | 0.25 (0.010) | 17 (0.67) | SS | 25.4 (1.0) | 260 | 4 | 130 | V-0 | All | * |

WIRING, PRINTED - COMPONENT | UL Product iQ

| O-LEADING- S02 | 0.2 (0.008) | 0.2 (0.008) | 17 (0.67) | SS | 25.4 (1.0) | 260 | 4 | 130 | НВ | | * |
|-------------------|--------------|--------------|-----------|----|------------|-----|---|-----|-----|-----|---|
| O-LEADING- S03 | 0.25 (0.010) | 0.25 (0.010) | 34 (1.34) | SS | 25.4 (1.0) | 260 | 4 | 130 | V-0 | All | * |

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

并不是所有出现在本数据库中的公司名称和产品都满足了UL跟踪检验服务的要求。只有带有 UL 标志的产品,才应该被视为经过 UL认证,并满足UL 跟踪检验服务的要求。注意查看产品上的标志。

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Packaging & Delivery

Shipping service





| Quick Turn Lead Time | | | | | |
|----------------------|----------|---------------------|--|--|--|
| Layer Count: | Lead Tim | Special Requirement | | | |
| 1L/2L | 2-3days | 24 Hours,48 Hours | | | |
| 4L | 3-4days | 48 Hours | | | |
| 6L | 4-5days | 72 Hours | | | |
| 8L | 5-6days | NA | | | |
| 10L | 6-7days | NA | | | |
| 12L | 7-8days | NA | | | |
| 14L | 8-9days | NA | | | |

| | Standard Lead Time | | | | | | |
|--------------|--------------------|------------------------|--|--|--|--|--|
| Layer Count: | Sample Lead Time | Volume order lead time | | | | | |
| 2L | 4 days | 10 days | | | | | |
| 4L | 5 days | 11 days | | | | | |
| 6L | 6 days | 12 days | | | | | |
| 8L | 8 days | 14 days | | | | | |
| 10L | 10 days | 16 days | | | | | |
| 12L | 12 days | 18 days | | | | | |
| 14L | 14 days | 20 days | | | | | |
| 16-32L | 18 days | 24 days | | | | | |

Process Capability

PCB Production Capabilities

Layer Count: 1Layer-32Layer Finished copper thickness[] 1/3oz-12oz Min Line width/spacing internal[] 3.0mil/3.0mil Min Line width/spacing external: 4.0mil/4.0mil Max Aspect Ratio: 10:1 Board thickness[] 0.2mm-5.0mm Max Panel size(inches): 635*1500mm Minimum Drilled Hole Size: 4mil Plated Hole Tolerance: +/-3mil Blind/Buried Vias (All Types): YES Via Fill(Conductive,Non-Conductive): YES Base Material: FR-4,FR-4high Tg.Halogen free material,Rogers,Aluminium base,Polyimide, Heavy Copper Surface finishes: HASL,OSP,ENIG,HAL-LF,Immersion silver,Immersion Tin,Gold fingers,Carbon ink

SMT Production Capabilities

PCB Material: FR-4,CEM-1,CEM-3,Aluminum-based board Max PCB size: 510x460mm Min PCB size[]50x50mm PCB Thickness[]0.5mm-4.5mm Board thickness[]0.5-4mm Min Components size: 0201 Standard chip size component: 0603 and larger Component max height[]15mm Min lead pitch: 0.3mm Min BGA ball pitch:0.4mm Placement precision: +/-0.03mm